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## **ON Semiconductor**®

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Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (\_), the underscore (\_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (\_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at <a href="https://www.onsemi.com">www.onsemi.com</a>. Please email any questions regarding the system integration to <a href="https://www.onsemi.com">Fairchild\_questions@onsemi.com</a>.

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Symbol	Param	neter		Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			30	V	
V <sub>GS</sub>	Gate to Source Voltage		(Note 4)	±20	V	
Ι <sub>D</sub>	Drain Current -Continuous	T <sub>C</sub> = 25 °C	(Note 5)	267		
	-Continuous	T <sub>C</sub> = 100 °C	(Note 5)	169	•	
	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	36	Α	
	-Pulsed		(Note 6)	1210		
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	544	mJ	
P <sub>D</sub>	Power Dissipation	T <sub>C</sub> = 25 °C		104	14/	
	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.5	W	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temper	ature Range		-55 to +150	°C	

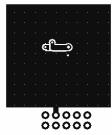
### **Thermal Characteristics**

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	1.2	°C/W
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient (Note 1a	) 50	C/ W

### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS7650	FDMS7650	Power 56	13 "	12 mm	3000 units

cteristics         Drain to Source Breakdown Voltage         Breakdown Voltage Temperature         Coefficient         Zero Gate Voltage Drain Current         Gate to Source Leakage Current	$I_{D} = 250 \ \mu\text{A}, \ V_{GS} = 0 \ V$ $I_{D} = 250 \ \mu\text{A}, \ \text{referenced to } 25 \ ^{\circ}\text{C}$ $V_{DS} = 24 \ V, \ V_{GS} = 0 \ V$	30			1	
Breakdown Voltage Temperature Coefficient Zero Gate Voltage Drain Current	$I_D = 250 \ \mu$ A, referenced to 25 °C	30				
Breakdown Voltage Temperature Coefficient Zero Gate Voltage Drain Current	$I_D = 250 \ \mu$ A, referenced to 25 °C				V	
-	V <sub>DS</sub> = 24 V, V <sub>GS</sub> = 0 V		15		mV/°C	
Gate to Source Leakage Current			-	1	μA	
	V <sub>GS</sub> = 20 V, V <sub>DS</sub> = 0 V			100	nA	
cteristics				.1	1	
	$V_{cc} = V_{cc}$ $l_{c} = 250 \mu A$	1	19	3	V	
Gate to Source Threshold Voltage	$I_D = 250 \ \mu\text{A}$ , referenced to 25 °C		-6		mV/°C	
Static Drain to Source On Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 36 A		0.8	0.99		
			1.1	1.55 m		
			1.1	1.7	-	
Forward Transconductance	$V_{DS} = 5 \text{ V}, I_D = 36 \text{ A}$		267		S	
Output Capacitance Reverse Transfer Capacitance Gate Resistance Characteristics Turn-On Delay Time Rise Time	$V_{DS} = 15 V, V_{GS} = 0 V,$ f = 1  MHz $V_{DD} = 15 V, I_D = 36 \text{ A},$		3050 240 1.4 28 24	4055 360 3 45	pF pF Ω ns	
Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge	$V_{GS} = 10 \text{ V}, \ \bar{R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $V_{DD} = 15 \text{ V},$		83 21 149 63	38 133 34 209 88	ns ns nC nC	
Fall Time         Total Gate Charge         Total Gate Charge         Gate to Source Charge	$V_{GS} = 10 \text{ V},  \text{R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V} \text{ to } 10 \text{ V}$		83 21 149 63 34	133 34 209	ns ns nC nC nC	
Fall Time         Total Gate Charge         Total Gate Charge         Gate to Source Charge         Gate to Drain "Miller" Charge         Ince Diode Characteristics	$V_{GS} = 10 \text{ V},        $		83 21 149 63	133 34 209	ns ns nC nC nC nC	
Fall TimeTotal Gate ChargeTotal Gate ChargeGate to Source ChargeGate to Drain "Miller" Charge	$V_{GS} = 10 \text{ V}, \ \bar{R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $V_{DD} = 15 \text{ V},$		83 21 149 63 34 13	133 34 209 88	ns ns nC nC nC	
Fall Time         Total Gate Charge         Total Gate Charge         Gate to Source Charge         Gate to Drain "Miller" Charge         Ince Diode Characteristics	$V_{GS} = 10 \text{ V},        $		83 21 149 63 34 13 0.7	133 34 209 88 1.2	ns ns nC nC nC nC	
	Temperature Coefficient Static Drain to Source On Resistance Forward Transconductance Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Characteristics Turn-On Delay Time	Gate to Source Threshold Voltage Temperature Coefficient $I_D = 250 \ \mu$ A, referenced to 25 °CStatic Drain to Source On Resistance $V_{GS} = 10 \ V, I_D = 36 \ A$ Static Drain to Source On Resistance $V_{GS} = 4.5 \ V, I_D = 32 \ A$ VGS = 10 V, I_D = 36 \ A, T_J = 125 °CForward Transconductance $V_{DS} = 5 \ V, I_D = 36 \ A$ CharacteristicsInput CapacitanceOutput CapacitanceGate ResistanceCharacteristicsGate ResistanceTurn-On Delay Time	$ \begin{array}{ c c c c c } \hline Gate to Source Threshold Voltage Temperature Coefficient & I_D = 250 \ \mu\text{A}, referenced to 25 \ ^{\circ}\text{C} \\ \hline \\ \hline \\ Static Drain to Source On Resistance & \hline \\ \hline$	$ \begin{array}{ c c c c } \hline Gate to Source Threshold Voltage \\ \hline Temperature Coefficient & I_D = 250 \ \mu\text{A}, referenced to 25 \ ^{\circ}\text{C} & -6 \\ \hline V_{GS} = 10 \ V, \ I_D = 36 \ \text{A} & 0.8 \\ \hline V_{GS} = 4.5 \ V, \ I_D = 32 \ \text{A} & 1.1 \\ \hline V_{GS} = 10 \ V, \ I_D = 36 \ \text{A}, \ T_J = 125 \ ^{\circ}\text{C} & 1.1 \\ \hline Forward Transconductance & V_{DS} = 5 \ V, \ I_D = 36 \ \text{A} & 267 \\ \hline \hline Characteristics & & & & & & & & & & & & & & & & & & &$	$\begin{tabular}{ c c c c c } \hline Gate to Source Threshold Voltage Temperature Coefficient & I_D = 250 \ \mu\text{A}, referenced to 25 \ ^{\circ}\text{C} & -6 & & & & & & & & & & & & & & & & & $	

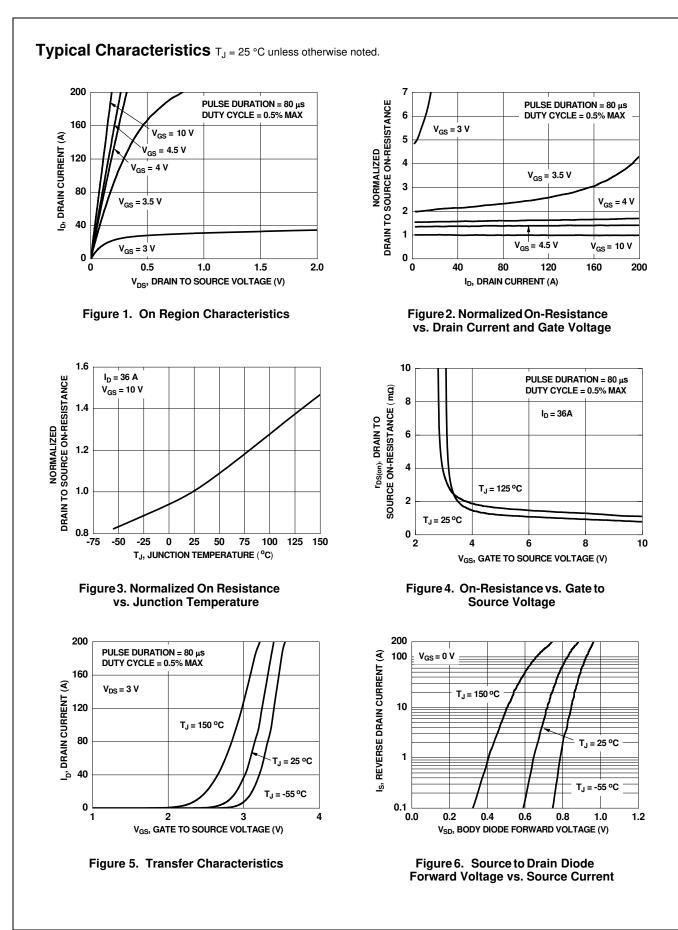




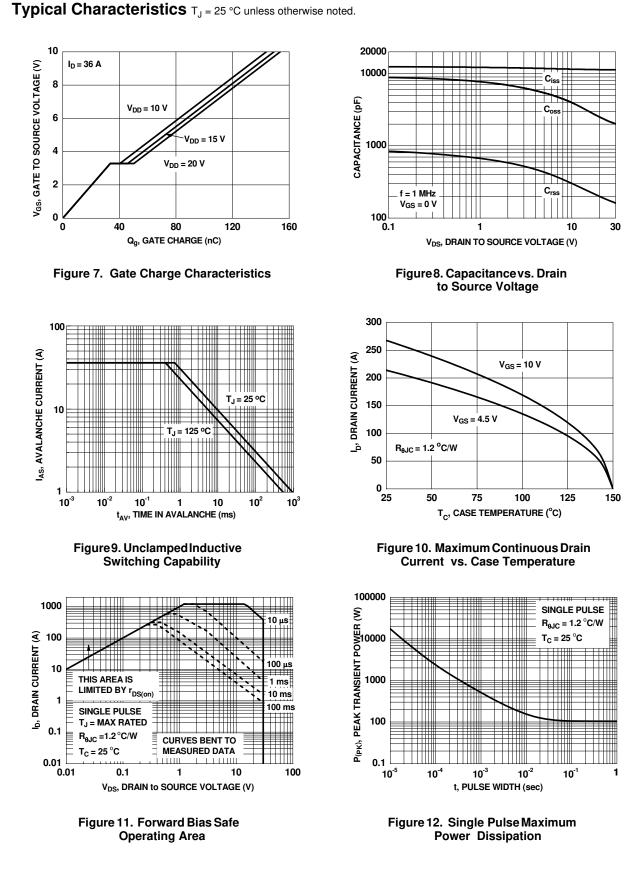


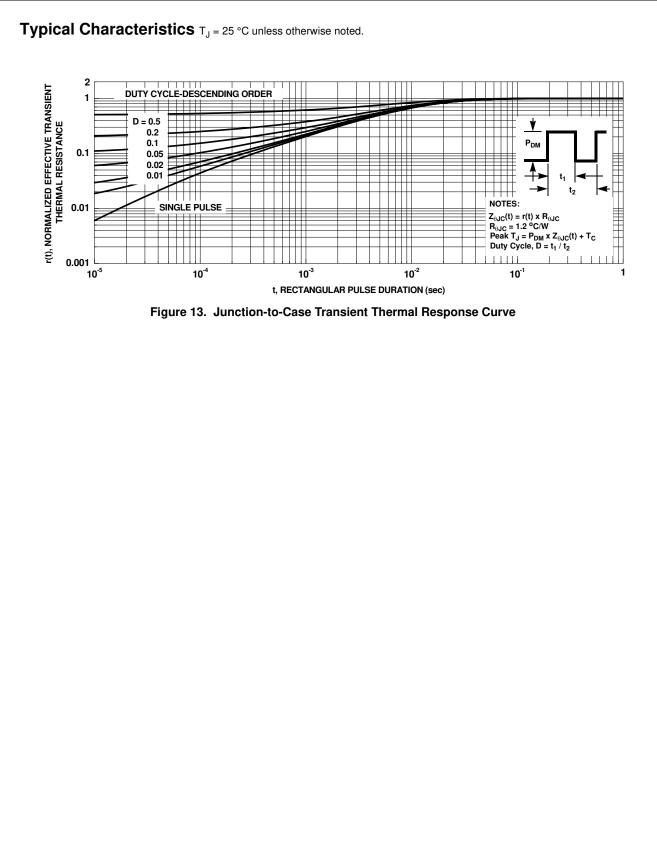
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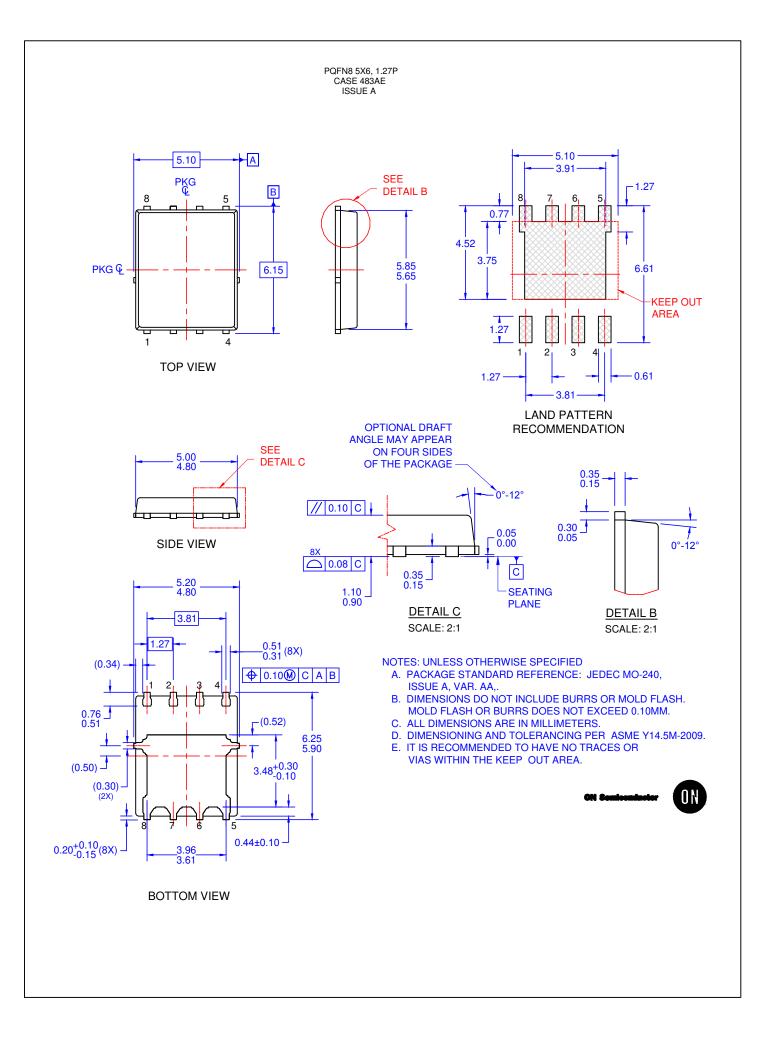
Pulse Test: Pulse Width < 300 ms, Duty cycle < 2.0%.</li>
 Starting T<sub>J</sub> = 25 °C, L = 1 mH, I<sub>AS</sub> = 33 A, V<sub>DD</sub> = 27 V, V<sub>GS</sub> = 10 V.
 As an N-ch device, the negative Vgs rating is for low duty cycle pulse ocurrence only. No continuous rating is implied.
 Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.
 Pulsed Id please refer to Fig 11 SOA graph for more details.











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